Search Notes

| Application/Control No. | Applicant(s)/Patent Under Reexamination |
|-------------------------|---|
| 10664978 | HASEBE ET AL. |
| Examiner | Art Unit |
| Wai-Sing Louie | 2814 |

| SEARCHED | | | | |
|----------|---------------|---------|----------|--|
| Class | Subclass | Date | Examiner | |
| 257 | 98,99,100,676 | 12/1/08 | WSL | |

| SEARCH NOTES | | |
|--|---------|----------|
| Search Notes | Date | Examiner |
| packaging, mounting plate, reflector cup, chip, terminal, bond pad, lead | 2/11/08 | WSL |
| frame, bond wire | | |
| followup search | 12/1/08 | WSL |

| INTERFERENCE SEARCH | | | |
|---------------------|---------------|---------|----------|
| Class | Subclass | Date | Examiner |
| 257 | 98,99,100,676 | 12/1/08 | WSL |

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